

## **Packages**



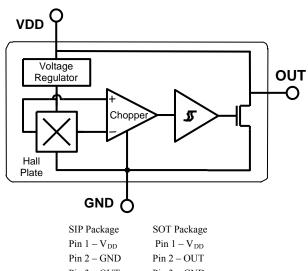
3 pin SOT23 (suffix SO)

3 pin SIP (suffix UA)

### **Features and Benefits**

- Wide operating voltage range from 2.5V to 24V
- High magnetic sensitivity Multi-purpose
- CMOS technology
- Low current consumption
- Chopper-stabilized amplifier stage
- Output driver with internal pull-up resistor
- Superior temperature stability
- Insensitive to physical stress
- Tiny SOT23 3L or flat SIP 3L both RoHS Compliant packages

## **Functional Block Diagram**



Pin 3 – OUT Pin 3 – GND

## **Application Examples**

- Automotive, Consumer and Industrial
- Solid-state switch
- Brushless DC motor commutation
- Speed detection
- Angular position detection
- Linear position detection
  - Proximity detection

# **General Description**

The SS569 is a bipolar Hall effect sensor IC fabricated from mixed signal CMOS technology. The device integrates a voltage regulator, Hall sensor with dynamic offset cancellation system, Schmitt trigger and an output driver with internal pull-up resistor, all in a single package.

It incorporates advanced chopper stabilization techniques to provide accurate and stable magnetic switch points. There are many applications for this HED - Hall Electronic Device - in addition to those listed above. The design, specifications and performance have been optimized for commutation applications in 5V and 12V brushless DC motors.

Thanks to its wide operating voltage range and extended choice of temperature range, it is quite suitable for use in automotive, industrial and consumer applications.

The device is delivered in a Small Outline Transistor (SOT) for surface mount process or in a Plastic Single In Line (SIP 3L flat) for through- hole mount. Both 3-lead packages are RoHS compliant.



## **Glossary of Terms**

MilliTesla (mT), Gauss Units of magnetic flux density: 1mT = 10 Gauss

RoHS Restriction of Hazardous Substances

SOT Small Outline Transistor (SOT package) - also referred with the package code "SO"

ESD Electro-Static Discharge
BLDC Brush-Less Direct-Current

Operating Point (B<sub>OP</sub>) Magnetic flux density applied on the branded side of the package which turns the output

driver ON  $(V_{OUT} = V_{DSon})$ 

Release Point (B<sub>RP</sub>) Magnetic flux density applied on the branded side of the package which turns the output

driver OFF ( $V_{OUT} = high$ )

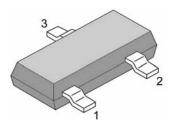
# **Unique Features**

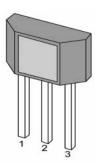
Based on mixed signal CMOS technology, SS569 is a Hall-effect device with high magnetic sensitivity. This multi-purpose latch meets most of the application requirements.

The chopper-stabilized amplifier uses switched capacitor technique to suppress the offset generally observed with Hall sensors and amplifiers. The CMOS technology makes this advanced technique possible and contributes to smaller chip size and lower current consumption than bipolar technology. The small chip size is also an important factor to minimize the effect of physical stress. This combination results in more stable magnetic characteristics and enables faster and more precise design.

The wide operating voltage from 2.5V to 24V, low current consumption and large choice of operating temperature range according to "L", and "E" specification make this device suitable for automotive, industrial and consumer applications.

# Pin Definitions and Descriptions





SOT Pin №	SIP Pin №	Name	Туре	Function
1	1	VDD	Supply	Supply Voltage pin
2	3	OUT	Output	Open Drain Output pin
3	2	GND	Ground	Ground pin

Table 1: Pin definitions and descriptions



# **Absolute Maximum Ratings**

Parameter	Symbol	Value	Units
Supply Voltage	$V_{DD}$	28	V
Supply Current	$I_{DD}$	50	mA
Output Voltage	V <sub>OUT</sub>	28	V
Output Current	I <sub>OUT</sub>	50	mA
Storage Temperature Range	$T_S$	-50 to 150	°C
Maximum Junction Temperature	$T_J$	165	°C

Table 2: Absolute maximum ratings

<b>Operating Temperature Range</b>	Symbol	Value	Units
Temperature Suffix "E"	$T_A$	-40 to 85	°C
Temperature Suffix "L"	$T_A$	-40 to 150	°C

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# **General Electrical Specifications**

DC Operating Parameters  $T_A = 25^{\circ}C$ ,  $V_{DD} = 2.5V$  to 24V (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Supply Voltage	$V_{DD}$	Operating	2.2		24	V
Supply Current	$I_{DD}$	$B < B_{RP}$			5	mA
Output Saturation Voltage	V <sub>DSon</sub>	$I_{OUT} = 20 \text{mA}, B > B_{OP}$			0.5	V
Output Leakage Current	I <sub>OFF</sub>	$B < B_{RP} V_{OUT} = 24V$		1	10	μA
Output Rise Time	t <sub>r</sub>	$R_L = 1k\Omega, C_L = 20pF$		0.25		μs
Output Fall Time	$t_{\mathrm{f}}$	$R_L = 1k\Omega, C_L = 20pF$		0.25		μs
Internal pull-up resistor	Rpu		9	12	15	kΩ
Maximum Switching Frequency	$F_{SW}$			10		KHz
Package Thermal Resistance	R <sub>TH</sub>	Single layer (1S) Jedec board		301		°C/W

Table 3: Electrical Specifications

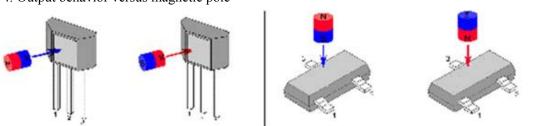
**Note**: The output of SS569 will be switched after the supply voltage is over 2.2V, but the magnetic characteristics won't be normal until the supply is over 2.5V.

# **Output Behavior versus Magnetic Pole**

DC Operating Parameters  $T_A = -40^{\circ}\text{C}$  to  $150^{\circ}\text{C}$ ,  $V_{DD} = 2.5\text{V}$  to 24V (unless otherwise specified)

Parameter	<b>Test Conditions (SO)</b>	OUT (SO)	Test Conditions (UA)	OUT (UA)
South pole	$B < B_{RP}$	High	$B > B_{OP}$	Low
North pole	$B > B_{OP}$	Low	$B < B_{RP}$	High

Table 4: Output behavior versus magnetic pole





# **Magnetic Specifications**

DC Operating Parameters  $V_{DD} = 2.5V$  to 24V (unless otherwise specified) SS569

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Operating Point	B <sub>OP</sub>		10	18	30	G
Release Point	$B_{RP}$	E spec., $T_A = 85^{\circ}C$	-30	-18	-10	G
Hysteresis	B <sub>HYST</sub>			36		G
Operating Point	$B_{OP}$		8	18	35	G
Release Point	$B_{RP}$	E spec., $T_A = 85^{\circ}C$	-35	-18	-8	G
Hysteresis	B <sub>HYST</sub>			36		G
Operating Point	B <sub>OP</sub>		5	18	40	G
Release Point	$B_{RP}$	L spec., $T_A = 150$ °C	-40	-18	-5	G
Hysteresis	$B_{HYST}$			36		G

Table 4: Magnetic Specifications

## **Detailed General Description**

The SS569 exhibits latch magnetic switching characteristics. Therefore, it requires both south and north poles to operate properly.

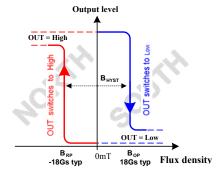
The OUT pin of these devices switches low (turns on) when a magnetic field perpendicular to the Hall sensor exceeds the operate point threshold,  $B_{OP}$ . After turn-on, the output voltage is  $V_{DSon}$ . Note that the device latches, that is, a south pole of sufficient strength towards the branded surface of the device turns the device on. The device remains on if the south pole is removed ( $B\rightarrow 0$ ). This latching property defines the device as a magnetic memory.

When the magnetic field is reduced below the release point,  $B_{RP}$ , the OUT pin turns off (goes high). The difference in the magnetic operating and release points is the hysteresis,  $B_{HYST}$ , of the device. This built-in hysteresis prevents output oscillation near the switching point, and allows clean switching of the output even in the presence of external mechanical vibration and electrical noise.

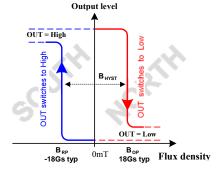
The device behaves as a latch with symmetric operating and release switching points  $(B_{OP}=|B_{RP}|)$ . This means magnetic fields with equivalent strength and opposite direction drive the output high and low.

Powering-on the device in the hysteresis region (less than  $B_{OP}$  and higher than  $B_{RP}$ ) allows an indeterminate output state. The correct state is attained after the first excursion beyond  $B_{OP}$  or  $B_{RP}$ .

The SOT-23 device is reversed from the UA package. The SOT-23 output transistor will be latched on in the presence of a sufficiently strong North pole magnetic field applied to the marked face.



UA package - Latch characteristic



SO package - Latch characteristic



## **Application Information**

It is strongly recommended that an external bypass capacitor be connected (in close proximity to the Hall sensor) between the supply (VDD Pin) and ground (GND Pin) of the device to reduce both external noise and noise generated by the chopper stabilization technique. As is shown in the two figures in next page, a 0.1µF capacitor is typical.

For reverse voltage protection, it is recommended to connect a resistor or a diode in series with the VDD pin. When using a resistor, three points are important:

- the resistor has to limit the reverse current to 50mA maximum ( $V_{CC}$  /  $R1 \le 50mA$ )
- the resulting device supply voltage  $V_{DD}$  has to be higher than  $V_{DD}$  min ( $V_{DD} = V_{CC} R1*I_{DD}$ )
- the resistor has to withstand the power dissipated in reverse voltage condition ( $P_D = V_{CC}^2/R1$ )

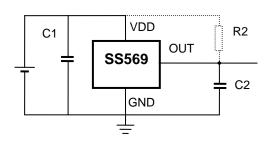
When using a diode, a reverse current cannot flow and the voltage drop is almost constant (≈0.7V).

Therefore, a  $100\Omega/0.25W$  resistor for 5V application and a diode for higher supply voltage are recommended. Both solutions provide the required reverse voltage protection.

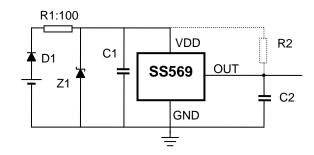
When a weak power supply is used or when the device is intended to be used in noisy environment, it is recommended that the figure 13.3 from the Application Information section is used.

The low-pass filter formed by R1 and C1 and the Zener diode Z1 bypass the disturbances or voltage spikes occurring on the device supply voltage  $V_{DD}$ . The diode D1 provides additional reverse voltage protection.

**Typical Three-Wire Application Circuit** 

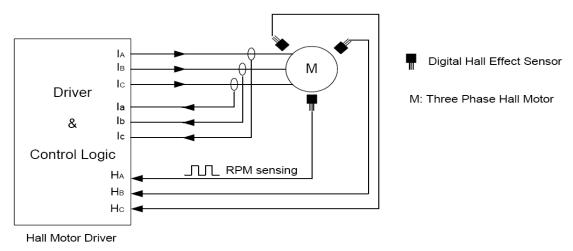


# Automotive and Severe Environment Protection Circuit



The SS569 have been optimized for commutation applications in 5V and 12V brushless DC motors. The follow figure is the typical application circuit for 3 phase brushless DC motors.





3 Phase Hall Motor

### Standard information regarding manufacturability of Hall IC with different soldering processes

Our products are classified and qualified regarding soldering technology, solderability and moisture sensitivity level according to following test methods:

### **Reflow Soldering SMD's (Surface Mount Devices)**

IPC/JEDEC J-STD-020

Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices (classification reflow profiles according to table 5-2)

EIA/JEDEC JESD22-A113

Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing (reflow profiles according to table 2)

#### Wave Soldering SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

EN60749-20

Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat

EIA/JEDEC JESD22-B106 and EN60749-15

Resistance to soldering temperature for through-hole mounted devices

### Iron Soldering THD's (Through Hole Devices)

• EN60749-15

Resistance to soldering temperature for through-hole mounted devices

### Solderability SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

• EIA/JEDEC JESD22-B102 and EN60749-21

# Solderability

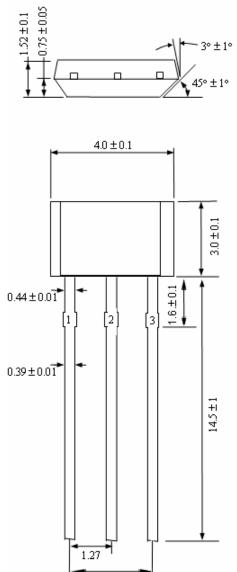
### **ESD Precautions**

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD).

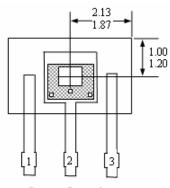
Always observe Electro Static Discharge control procedures whenever handling semiconductor products.

### Package UA, 3-Pin SIP:

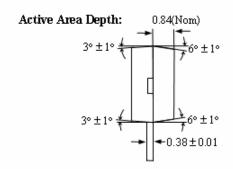




2.54



Sensor Location



### Notes:

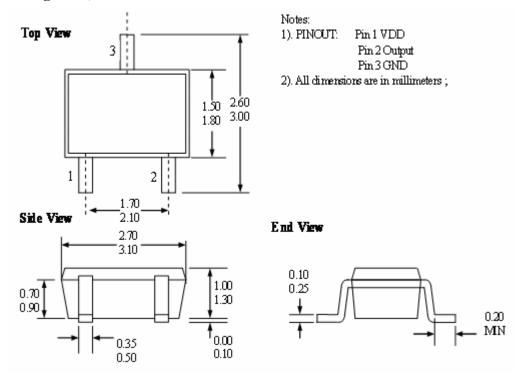
- 1). Controlling dimension: mm;
- 2). Lesds must be free of flash and plating voids;
- 3). Do not bend leads within 1 mm of lead to package interface ;
- 4). PINOUT: Pin 1 VDD

Pin 2 GND

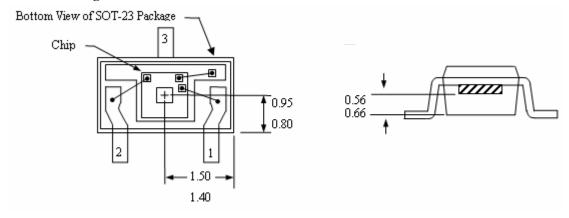
Pin 3 Output



### Package SOT, 3-Pin SOT-23:



### **SOT-23 Package Hall Location:**



# **Ordering Information**

Part No.	Pb-free	Temperature Code	Package Code	Packing
SS569ESOT	YES	-40°C to 85°C	SOT-23	7-in. reel, 3000 pieces/reel
SS569EUA	YES	-40°C to 85°C	TO-92	Bulk, 1000 pieces/bag
SS569KSOT	YES	-40°C to 125°C	SOT-23	7-in. reel, 3000 pieces/reel
SS569KUA	YES	-40°C to 125°C	TO-92	Bulk, 1000 pieces/bag
SS569LSOT	YES	-40°C to 150°C	SOT-23	7-in. reel, 3000 pieces/reel
SS569LUA	YES	-40°C to 150°C	TO-92	Bulk, 1000 pieces/bag